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## Electronic Filing System (EFS) Data Electronic Patent Application Submission USPTO Use Only

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EFS ID:

55594

Application ID:

09917842

Title of Invention:

ATOMIC LAYER DEPOSITION

**APPARATUS** 

First Named Inventor:

Barry Chin

Domestic/Foreign Application:

**Domestic Application** 

Filing Date:

2001-07-27

**Effective Receipt Date:** 

2004-02-16

Submission Type:

Information Disclosure

Statement

Filing Type:

Confirmation number:

3573

Attorney Docket Number:

5017Y01

Total Fees Authorized:

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Deposit Account Number:

200782

Deposit Account Name:

Keith P Taboada

Access Code:

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**RAM Payment Status:** 

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2004-02-16

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Trademark Office,ou=Department of Commerce,o=U.S. Government,c=US Certificate Message Digest: afb68e3d8948ec0dac9ba003fd6cd8b75eeb1f37



#### **TRANSMITTAL**

Électronic Version v1.1 Stylesheet Version v1.1.0

Title of Invention

ATOMIC LAYER DEPOSITION APPARATUS

Application Number:

09/917842

Date:

2001-07-27

First Named Applicant:

Barry L. Chin

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Submitted by:	Elec. Sign.	Sign. Capacity
Keith P Taboada Registered Number: 45150	/Keith P Taboada/	Attorney

Documents being submitted

**Files** 

us-ids

APPM5017Y01-usidst.xml

us-ids.dtd

us-ids.xsl

us-fee-sheet

APPM5017Y01-usfees.xml

us-fee-sheet.xsl

us-fee-sheet.dtd



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#### FEE TRANSMITTAL

Electronic Version v08 Stylesheet Version v08.0

> Title of Invention

ATOMIC LAYER DEPOSITION APPARATUS

Application Number:

09/917842

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Date:

2001-07-27

First Named Applicant:

Barry L. Chin

Attorney Docket Number: 5017Y01

Art Unit:

Examiner:

3573

Alexander Kosowski

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### **TOTAL FEE AUTHORIZED \$180**

Patent fees are subject to annual revisions on or about October 1st of each year.

#### BASIC FILING FEE

Fee Description	Fee Code	Amount \$	Fee Paid \$
Submission Of Information Disclosure Stmt Fee.	1806	180	180

#### AUTHORIZED BILLING INFORMATION

The commissioner is hereby authorized to charge indicated fees and credit any overpayments to:

Deposit account number: 200782

Access Code

Deposit name:

Moser Patterson Sheridan LLP

Deposit authorized name: Keith P Taboada

Signature:

/Keith P Taboada/

Date (YYYYMMDD):

2004-02-13



#### **FEE TRANSMITTAL**

Electronic Version v08 Stylesheet Version v08.0

Title of Invention

ATOMIC LAYER DEPOSITION APPARATUS

Application Number:

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Date:

2001-07-27

First Named Applicant:

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Examiner:

Alexander Kosowski

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Signature:

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Date (YYYYMMDD):

2004-02-13



#### **ELECTRONIC INFORMATION DISCLOSURE STATEMENT**

Electronic Version v18 Stylesheet Version v18.0

> Title of Invention

#### ATOMIC LAYER DEPOSITION APPARATUS

Application Number:

09/917842

Confirmation Number:

3573

First Named Applicant:

**Barry Chin** 

Attorney Docket Number: 5017Y01

Art Unit:

3573

Examiner: Search string: Alexander Kosowski

( 6630030 or 6579372 or 6578287 or 6572705

or 6551406 or 6511539 or 6481945 or 6478872 or 6447607 or 6306216 or 6305314 or 6270572

or 6231672 or 6200893 or 6197683 or 6183563 or 6174377 or 6139700 or 6042652 or 6015590or 5916365 or 5879459 or 5855680 or 5835677

or 5807792 or 5796116 or 5730802 or 5711811 or 5674786 or 5503875 or 5483919 or 5480818 or 5443647 or 5441703 or 5374570 or 5338362 or 5294286 or 5281274 or 5261959 or 5225366

or 4993357 or 4975252 or 4834831 or 4413022

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#### **US Patent Documents**

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

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	2	6579372	2003-06-17	Park	B2		
	3	6578287	2003-06-17	Aswad	B2		
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	6	6511539 <sup>-</sup>	2003-01-28	Raaijmakers	,		
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Note: Remarks are not for responding to an office action.

This Information Disclosure Statement is being filed in conjuction with a PAPER Information Disclosure Statement referencing Foreign patent. The necessary Fee being submitted herewith is for both Information Disclosure Statements.

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